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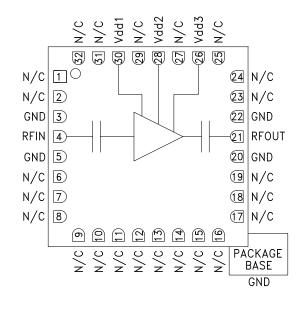
# GaAs SMT PHEMT LOW NOISE AMPLIFIER, 6 - 20 GHz

### Typical Applications

The HMC565LC5 is ideal for use as a LNA or driver amplifier for:

- Point-to-Point Radios
- Point-to-Multi-Point Radios & VSAT
- Test Equipment and Sensors
- Military & Space

## **Functional Diagram**



#### **Features**

Noise Figure: 2.5 dB

Gain: 21 dB OIP3: 20 dBm

Single Supply: +3V @ 53 mA 50 Ohm Matched Input/Output

RoHS Compliant 5 x 5 mm Package

### **General Description**

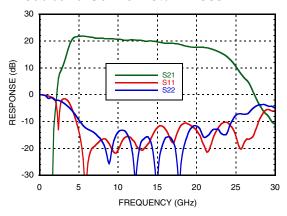
The HMC565LC5 is a high dynamic range GaAs pHEMT MMIC Low Noise Amplifier housed in a leadless RoHS compliant 5x5mm SMT package. Operating from 6 to 20 GHz, the HMC565LC5 features 21 dB of small signal gain, 2.5 dB noise figure and IP3 of +20 dBm across the operating band. This self-biased LNA is ideal for microwave radios due to its single +3V supply operation, and DC blocked RF I/O's.

# Electrical Specifications, $T_A = +25^{\circ}$ C, Vdd 1, 2, 3 = +3V

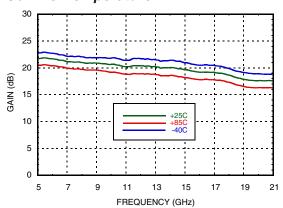
Parameter	Min.	Тур.	Max.	Min.	Тур.	Max.	Units
Frequency Range		6 - 12			12 - 20		GHz
Gain	19	21		16	18.5		dB
Gain Variation Over Temperature		0.025	0.035		0.025	0.035	dB/ °C
Noise Figure		2.5	2.8		2.5	3	dB
Input Return Loss		15			12		dB
Output Return Loss		13			15		dB
Output Power for 1 dB Compression (P1dB)	8	10		9	11		dBm
Saturated Output Power (Psat)		11			13		dBm
Output Third Order Intercept (IP3)		20			21		dBm
Total Supply Current (Idd)(Vdd = +3V)		53	75		53	75	mA



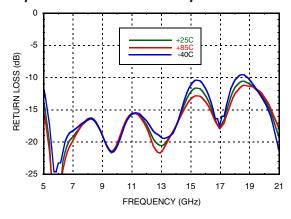
#### **Broadband Gain & Return Loss**



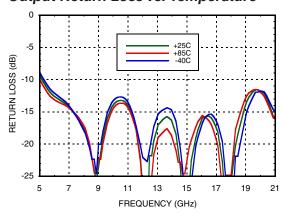
#### Gain vs. Temperature



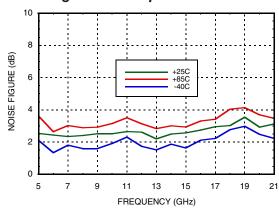
#### Input Return Loss vs. Temperature



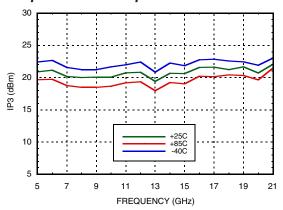
### **Output Return Loss vs. Temperature**



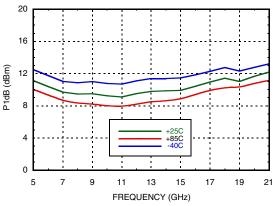
### Noise Figure vs. Temperature



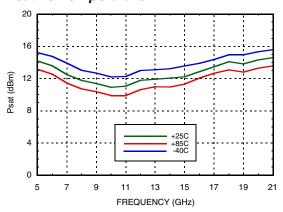
### Output IP3 vs. Temperature



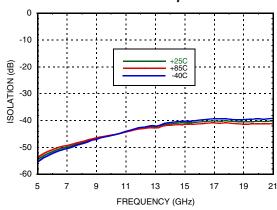
#### P1dB vs. Temperature



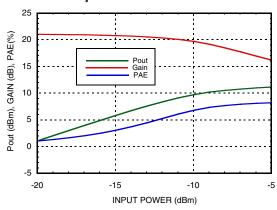
#### Psat vs. Temperature



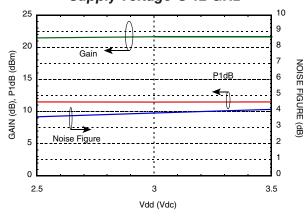
#### Reverse Isolation vs. Temperature



#### **Power Compression @ 12 GHz**



### Gain, Noise Figure & Power vs. Supply Voltage @ 12 GHz





#### **Absolute Maximum Ratings**

Drain Bias Voltage (Vdd1, Vdd2, Vdd3)	+3.5 Vdc
RF Input Power (RFIN)(Vdd = +3.0 Vdc)	10 dBm
Channel Temperature	175 °C
Continuous Pdiss (T= 85 °C) (derate 8.5 mW/°C above 85 °C)	0.753 W
Thermal Resistance (channel to ground paddle)	119.5 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C
ESD Sensitivity (HBM)	Class 1A

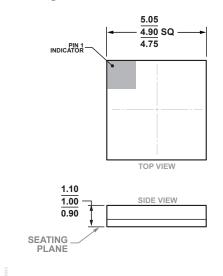
### Typical Supply Current vs. Vdd

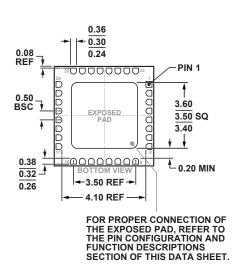
ldd (mA)		
1		
3		
6		



ELECTROSTATIC SENSITIVE DEVICE OBSERVE HANDLING PRECAUTIONS

### **Outline Drawing**





32-Terminal Ceramic Leadless Chip Carrier [LCC] (E-32-1)

#### **ORDERING GUIDE**

Part Number	Package Material	Lead Finish	MSL Rating [1]	Package Marking [2]
HMC565LC5	Alumina, White	Gold over Nickle	MSL3	<u>H565</u> XXXX
HMC565LC5TR	Alumina, White	Gold over Nickle	MSL3	<u>H565</u> XXXX
HMC565LC5TR-R5	Alumina, White	Gold over Nickle	MSL3	<u>H565</u> XXXX

<sup>[1]</sup> Max peak reflow temperature of 260 °C

Dimensions shown in millimeters.

<sup>[2] 4-</sup>Digit lot number XXXX



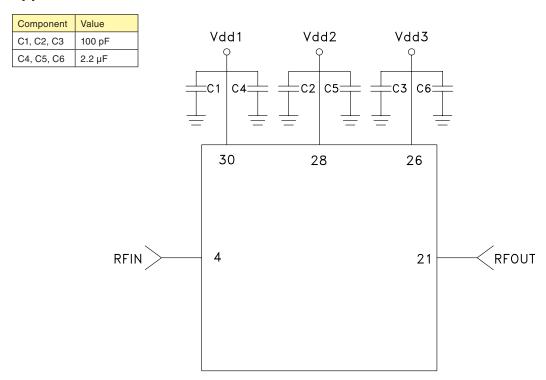
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# GaAs SMT PHEMT LOW NOISE AMPLIFIER, 6 - 20 GHz

### **Pin Descriptions**

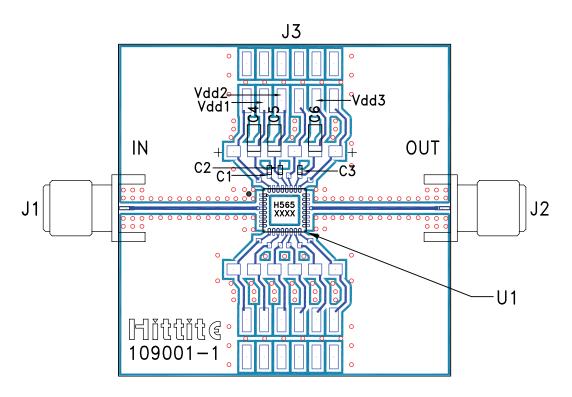
Pin Number	Function	Description	Interface Schematic
1, 2, 6 - 19, 23 - 25, 27, 29, 31, 32	N/C	This pin may be connected to RF/DC ground. Performance will not be affected.	
3, 5, 20, 22	GND	These pins and package bottom must be connected to RF/DC ground.	GND =
4	RFIN	This pin is AC coupled and matched to 50 Ohms.	RFIN ○── ├──
21	RFOUT	This pin is AC coupled and matched to 50 Ohms.	—
30, 28, 26	Vdd1, 2, 3	Power Supply Voltage for the amplifier. External bypass capacitors of 100 pF and 2.2 μF are required.	Vdd1,2,3

## **Application Circuit**





#### **Evaluation PCB**



#### List of Materials for Evaluation PCB 110431 [1]

Item	Description	
J1 - J2	PCB Mount K Connector	
J3	2 mm DC Header	
C1 - C3	100 pF Capacitor, 0402 Pkg.	
C4 - C6	2.2 µF Capacitor, Tantalum	
U1	HMC565LC5 Amplifier	
PCB [2]	109001 Evaluation PCB	

[1] Reference this number when ordering complete evaluation PCB

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation board should be mounted to an appropriate heat sink. The evaluation circuit board shown is available from Analog Devices upon request.

<sup>[2]</sup> Circuit Board Material: Rogers 4350